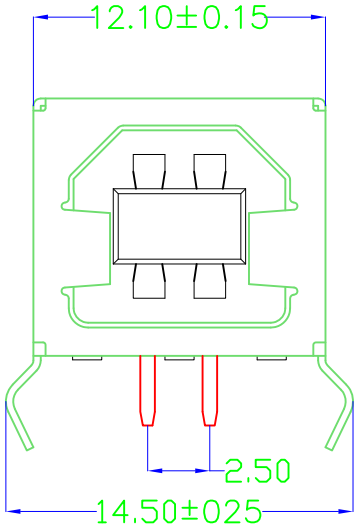
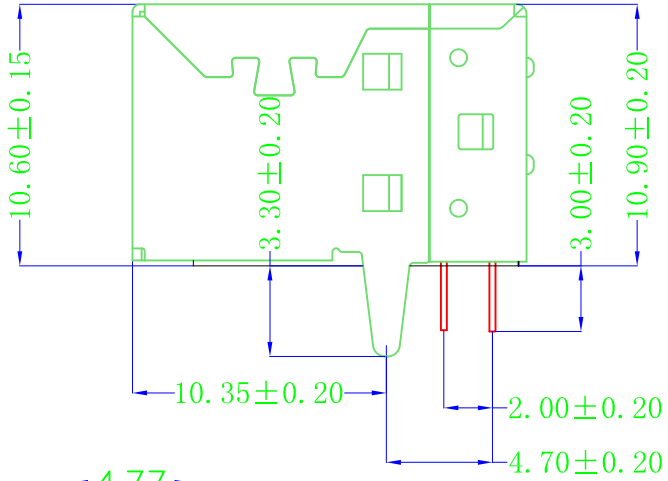
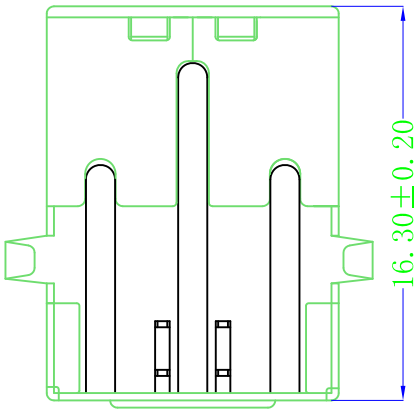
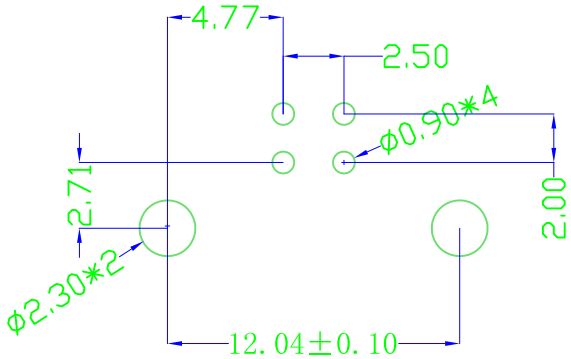
MAPX	MODIFICATION	DATE









P. C. B. LAYOUT

特性:Specifications:

电器:日ectrical:

1. 接触阻抗：Contact Resistance
   30 milliohms MAX
2. 耐电压：Dielectnic Withstanding Voitage:
   500 V AC AT Sea Levol
3. 绝缘抗阻：Lnsulation Resistance
   1000MEGA ohms MIN

材料:Matorial:

1. 塑胶：Housing:Hing Temperature Tnermaplastic
2. 端子：Contact:Coppre Alloy 铜合金
3. 铁壳：Shell:Copper Aiioy铜/铁合金

电镀：Finish:

1. 端子：Contact: Piated Golg in Mating Area:
   Tin On Solder Talls
   接触点镀金.脚镀锡
2. 铁壳：Shell:

Nickel Plating 镀镍

产品图 PRODUCT CHART DWG				深圳市精拓金电子有限公司							
公差一览表 TOLERANCE UNLESS OTHERMSE				单位 UNITS	MM	制图 DRAWING	邱建辉	制图料号 PRODUCT PART NO.			
X.	±0.25	X.	±5.°	比例 SCALE	1:1	审核 CHKD	郭治富	产品名称 PRODUCT NO.	USB B母90° 插板式		
.X	±0.20	.X	±2.°	日期 DATE	2016.05.11	核准 APPD	黄国荣	角法 VIEW		版本 VER	A0
.XX	±0.15	.XX	±1.°								
.XXX	±0.05	.XXX	±0.5°								